

SAW Components

BAW Bluetooth/WLAN Filter

Series/type: Ordering code:

B9604 B39242B9604P810

Date: Version: June 27, 2012 2.0

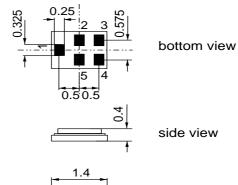
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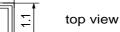
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		DOCOL
SAW Components		B9604
BAW Bluetooth/WLAN Filter		2441.0 MHz
Data Sheet	SMD	
Application		
 Low-loss RF filter for Bluetooth/W Band 7 coexistence Usable passband: 79.0 MHz Unbalanced to unbalanced operation Good insertion attenuation High out of band selectivity Filter impedance 50 Ω 		O tttt

Features

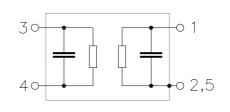
- Package size 1.4 x1.1 x 0.4 mm³
- RoHS compatible
- Approximate weight 0.003 g
- Package for Surface Mount Technology (SMT)
- Ni, gold-plated terminals
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 3





Pin configuration

- Input unbalanced
- 4 Output unbalanced
- 2,3,5 To be grounded



Please read *cautions and warnings and important notes* at the end of this document.

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SAW Components					B9604
BAW Bluetooth/WLAN Filter			24	441.0 MHz	
Data Sheet 🛛 🚝	:MD				
Characteristics					
Temperature range for specification:		20 °C to +	-85 °C		
		50 Ω (unba			
			nt coil 15n⊦	ł	
			B9604		
		min.	typ.	max.	
			@ 25 °C		
Center frequency	f _C		2441.0	—	MHz
Maximum insertion attenuation - BT ¹⁾	α_{max}				
2401.5 2480.5 MHz	max	_	1.9 ¹⁾	2.6 ¹⁾	dB
Maximum insertion attenuation - WLAN ²⁾	α_{max}				
2403.1 2480.9 MHz		—	2.4 ²⁾	3.3 ²⁾	dB
VSWR (Input and Output)					
2401.5 2480.9 MHz		—	1.8	2.3 ³⁾	
2401.5 2480.9 MHz		—	1.8	2.4	
Attenuation	α				
100.0 699.0 MHz		38	40	—	dB
699.0 960.0 MHz		35	38		dB
960.0 1428.0 MHz		34	37	—	dB
1428.0 1607.0 MHz		35	38	—	dB
1607.0 1995.0 MHz		37	39	—	dB
1995.0 2110.0 MHz		39	42	—	dB
2110.0 2170.0 MHz		42	45	—	dB
2300.0 2370.0 MHz		40	47	—	dB
2500.0 2502.0 MHz		26	60	—	dB
2500.0 2502.0 MHz		50 ⁴⁾	60	—	dB
2502.0 2530.0 MHz		50	60	—	dB
2530.0 2570.0 MHz		45	49	—	dB
2570.0 2690.0 MHz		43	47	—	dB
4800.0 5805.0 MHz		27	35		dB

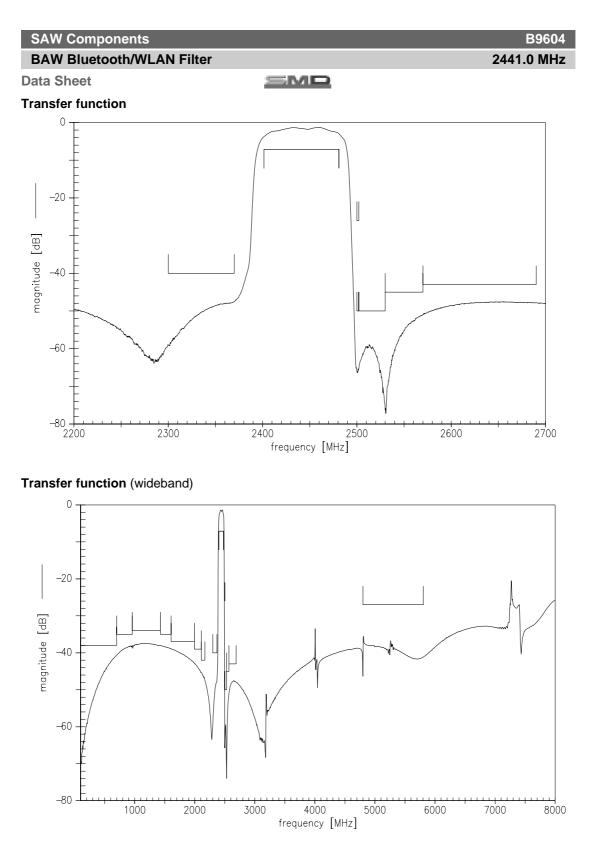
¹⁾ Averaged value over whole passband due to frequency hopping in Bluetooth mode
²⁾ Averaged for any 17.8 MHz BW over frequency range
³⁾ At +25 °C
⁴⁾ +25 °C to +85 °C

SAW Components				B9604
BAW Bluetooth/WLAN F	ilter			2441.0 MHz
Data Sheet		SM		
Maximum ratings				
Operable temperature range	Т	-30/+85	°C	
Storage temperature range	T _{stg}	-40/+85	°C	
DC voltage	V _{DC}	5	V	
ESD voltage	V _{ESD}	50 ¹⁾	V	Machine Model
ESD voltage		500 ²)	V	Human Body Model
•	V _{ESD}			-
ESD voltage	V_{ESD}	600 ³⁾	V	Charge Device Model
Input power at				20 MHZ OEDM signal 65 °C
Input power at	P _{IN}	24	dBm	20 MHz OFDM signal, 65 °C,
2401.5 - 2480.5 MHz	- IIN	·		2000hr

¹⁾ acc. to JESD22-A115A.

²⁾ acc. to JESD22-A114F.

³⁾ acc. to JESD22-C101.

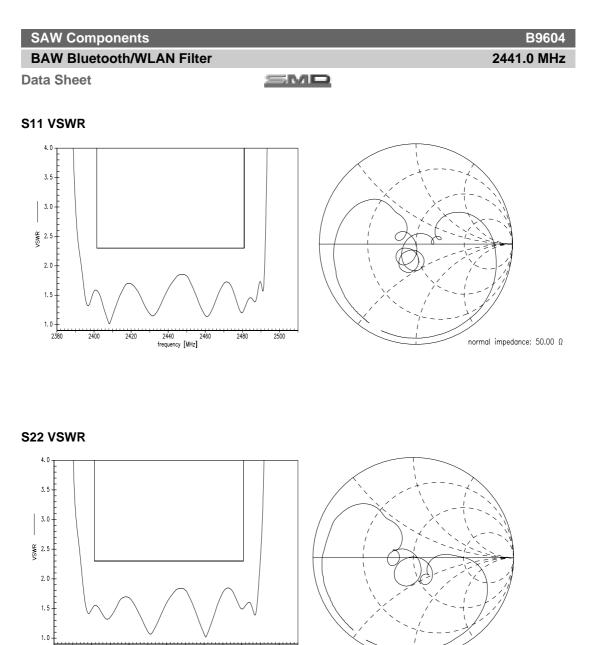


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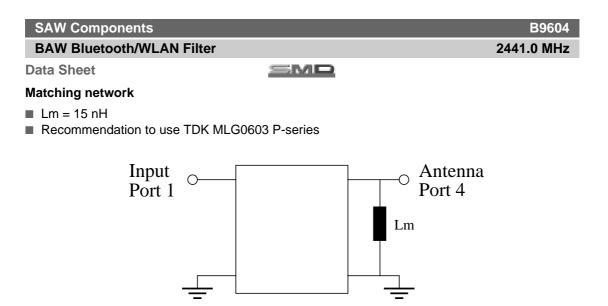
normal impedance: 50.00 Ω



frequency [MHz]

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SAW Components

B9604

BAW Bluetooth/WLAN Filter

2441.0 MHz

Data Sheet

References

Туре	B9604
Ordering code	B39242B9604P810
Marking and package	C61157-A8-A59
Packaging	F61074-V8212-Z000
Date codes	L_1126
S-parameters	B9604_NB.s2p B9604_WB.s2p See file header for port/pin assignment table
Soldering profile	S_6001
RoHS compatible	defined as compatible with the following documents: "DIRECTIVE 2002/95/EC OF THE EUROPEAN PARLIAMENT AND OF THE COUNCIL of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment. 2005/618/EC from April 18th, 2005, amending Directive 2002/95/EC of the European Parliament and of the Council for the purposes of establishing the maxi- mum concentration values for certain hazardous substances in electrical and electronic equipment."
Matching coils	See Inductor pdf-catalog <u>http://www.tdk.co.jp/tefe02/coil.htm#aname1</u> and Data Library for circuit simulation <u>http://www.tdk.co.jp/etvcl/index.htm</u>
Moldability	Before using in overmolding environment, please contact your EPCOS sales office.

SMD

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